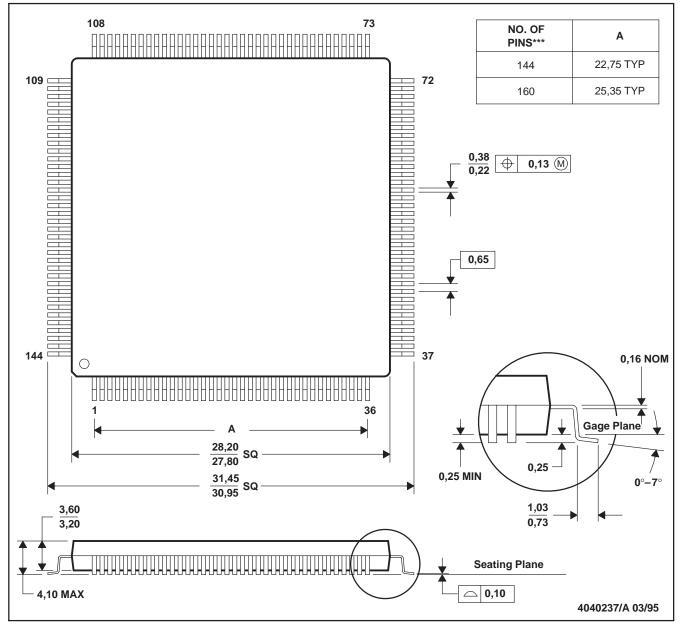
MECHANICAL DATA

MHQF007A - JANUARY 1995 - REVISED MAY 1999

PCE (S-PQFP-G***)

PLASTIC QUAD FLATPACK

144 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Thermally enhanced molded plastic package with a heat spreader (HSP)
- D. Falls within JEDEC MS-022
- E. The 144 PCE is identical to the 160 PCE except that four leads per corner are removed.



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